



PATENT  
0599-0207P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Yasushi SAWAMURA et al. Conf.: 7250  
Appl. No.: 09/940,513 Group: ~~1771~~ 1712  
Filed: August 29, 2001 Examiner: ~~V. Chang~~ K. Chen  
7C

For: ADHESIVE SHEET FOR SEMICONDUCTOR  
CONNECTING SUBSTRATE, ADHESIVE-BACKED  
TAPE FOR TAB, ADHESIVE-BACKED TAPE FOR  
WIRE BONDING CONNECTION, SEMICONDUCTOR  
CONNECTING SUBSTRATE, AND SEMICONDUCTOR  
DEVICE

RECEIVED  
APR 16 2003  
TC 1700

REPLY UNDER 37 C.F.R. § 1.111

Assistant Commissioner for Patents  
Washington, DC 20231

April 15, 2003

Sir:

In reply to the Examiner's Office Action dated January 15, 2003, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

IN THE CLAIMS:

Please cancel claims 24, 35 and 37 without prejudice or disclaimer of the subject matter contained therein.

Please replace the claims with the amended claims below:

1. (Amended) An adhesive sheet for a semiconductor connecting flexible substrate comprising a laminate having an adhesive layer



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- ☐ Petition for ( ) month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.
- ☒ No fee is required.
- ☐ Check(s) in the amount of \$0.00 is(are) enclosed.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By 

Andrew D. Meikle, #32,868

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0599-0207P

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Attachment(s)

(Rev. 10/15/02)